### Harvatek Surface Mount CHIP LEDs Data Sheet B2G32UYNB20C000213U1930

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Tentative Product	*******				
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DISCLAIMER
LIFE SUPPORT POLICY
PRODUCT SPECIFICATIONS
ATTENTION: ELECTROSTATIC DISCHARGE (ESD) PROTECTION4
LABEL SPECIFICATIONS
SPECIFICATIONS RANGE
PRODUCT FEATURES
ELECTRO-OPTICAL CHARACTERISTICS
PACKAGE OUTLINE DIMENSION AND RECOMMENDED SOLDERING PATTERN FOR REFLOW
Soldering7
Absolute Maximum Ratings7
CHARACTERISTICS OF B2G32UYNB8
PRECAUTION FOR USE
PRECAUTION FOR USE
PACKAGING 10
PACKAGING

7				
Official Product	HT Part No. B2G32UYNB20C000213U1930			
Tentative Product	***************************************			
	t to changes for improvement without advance awings, company confidential all rights reserved.	03/11/2021	Version 1.0	Page 2/15

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

7				
Official Product	HT Part No. B2G32UYNB20C000213U1930			
Tentative Product	***************************************			
	t to changes for improvement without advance awings, company confidential all rights reserved.	03/11/2021	Version 1.0	Page 3/15

#### **Product Specifications**

ltem	Specification	Material	Quantity
Luminous	UY:28.5-112.5 mcd		
Intensity(Iv)	NB:28.5-112.5 mcd		
	@20mA/ T <sub>s</sub> = 25 $^{\circ}$ C;Tolerance: <u>+</u> 10%		
Wavelength	UY:587-594.5 nm		
	NB:460.0-476.0 nm		
	@20mA/ Ts= 25°C; Tolerance: <u>+</u> 0.5nm		
Vf	UY:1.6-2.4 V		
	NB: 2.7-3.9 V		
	@20mA/ T_s= 25°C ;Tolerance: <u>+</u> 0.05V		
lr	< 10 µA @ V <sub>R</sub> = 5 V		
Resin	Clear	Ероху	
Carrier tape	EIA 481-1A specs	Conductive black tape	
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin

combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note : This is shipped test conditions

%Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

#### ATTENTION: Electrostatic Discharge (ESD) protection



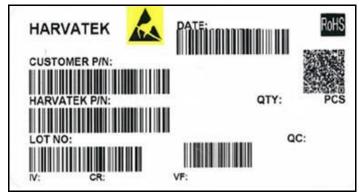
The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must

be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

7					
Official Product	HT Part No. B2G32UYNB20C000213U1930				
Tentative Product	***************************************				
	t to changes for improvement without advance awings, company confidential all rights reserved.	03/11/2021	Version 1.0	Page 4/15	

### **Label Specifications**



Harvatek P/N:

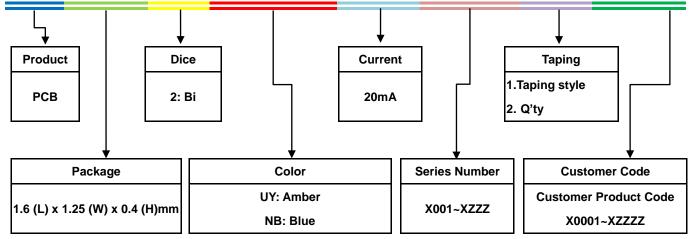
B 2

2G3 2

UYNB 20C

0002 13





#### Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	Α	1	Α	2	2	L	1	2
Cod	le 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special cod	e
		2010-A		1:A					
		2011-B		2:B					
		2012-C	1:Jan.	3:C					
			2:Feb.						
(atomat Ta	andre Orde	2018-I/J	1.444	26:Z	04	77		000 777	
internal i r	acing Code	2019-K	A:Oct.	27:7	01-	-ZZ		000~ZZZ	
		1.54	B:Nov.	28:8					
		2022-N	C:Dec.	29:9					
		2023-P	1000000000	30:3					
		2444		31:4					

Official Product	HT Part No. B2G32UYNB20C000213U1930				
Tentative Product	*********				
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#### **Specifications Range**

### Luminous Intensity (Iv) Bin:

,		
Color	Bin Code	Spec. Range
	Ν	28.50-45.00 mcd
UY	Р	45.00-71.50 mcd
	Q	71.50-112.5 mcd
	Ν	28.50-45.00 mcd
NB	Р	45.00-71.50 mcd
	Q	71.50-112.5 mcd

Note: It maintains a tolerance of ±10% on luminous intensity

### Wavelength Bin:

Color	Bin Code	Spec. Range
	С	587.0-589.5 nm
UY	D	589.5-592.0 nm
	E	592.0594.5 nm
	Α	460.0-464.0nm
	В	464.0-468.0nm
NB	С	468.0-472.0 nm
	D	472.0-476.0 nm

Note: It maintains a tolerance of ± 0.5nm on Wavelength BIN

### Forward Voltage (Vf) Bin:

,		1		
Color	Bin Code	Spec. Range		
UY	E18	1.6-2.4 V		
	G8	2.7-2.9 V		
	H7	2.9-3.1 V		
	H8	3.1-3.3 V		
NB	J7	3.3-3.5 V		
	J8	3.5-3.7 V		
	K7	3.7-3.9 V		

Note: It maintains a tolerance of ±0.05V on forward voltage measurements

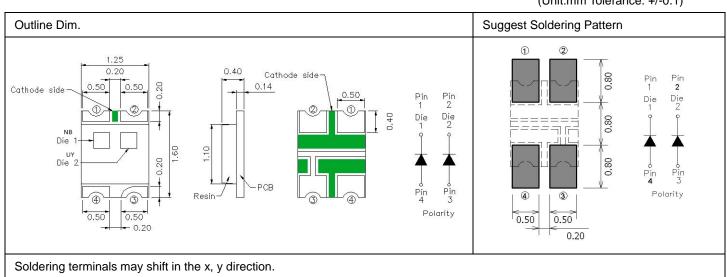
Official Product HT Part No. B2G32UYNB20C000213U1930					
Tentative Product	*****				
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#### **Product Features**

#### **Electro-Optical Characteristics**

								(T <sub>s</sub>	oldering , 25 °C)
		VF(V)		(V)	Wavelength λ(nm)		l <sub>∨</sub> (mcd)	Viewing	
Series	Emitting Color	Material	typ	max	$\lambda_{D}$	$\lambda_{P}$	Δλ	Typical	Angle $2\theta \frac{1}{2}$
	UY	UY AlGalnP	2.0	2.4	589	591	20	45.0	X=135
									Y=120
B2G32UYNB20			3.3	2.0	470	468	40	45.0	X=115
	NB	InGaN	3.3 3.9	3.9	470	400	40	45.0	Y=130

### Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering



### Absolute Maximum Ratings

(T<sub>Soldering</sub> 25 °C)

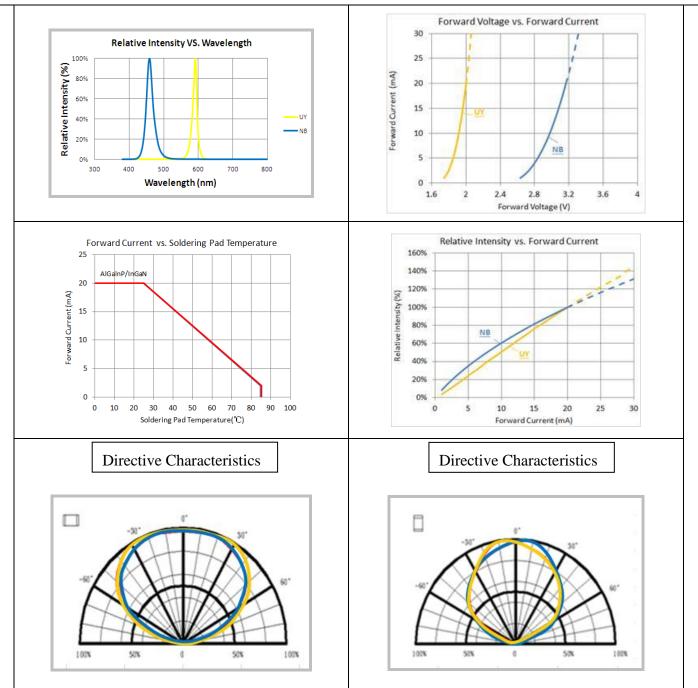
Series	P <sub>D</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> (mA)*	T <sub>OP</sub> (°C)	T <sub>ST</sub> (⁰C)
Color	Power	Forward	Pulse Forward	Operating	Storage
Color	Dissipation	Current	Current	Temperature	Temperature
UY	48	20	100	-40~+85	-40~+100
NB	78	20	80	-40~+85	-40~+100

\*Condition for  $I_{FP}$  is pulse of 1/10 duty and 0.1msec width

Official Product	HT Part No. B2G32UYNB20C000213U1930			
Tentative Product	*****	****		
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#### (Unit:mm Tolerance: +/-0.1)

### Characteristics of B2G32UYNB



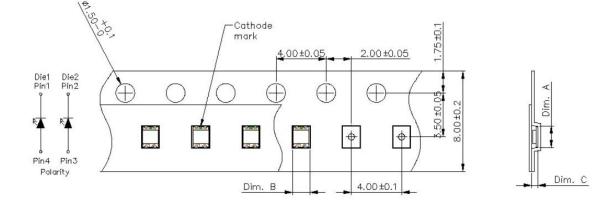
Official Product	HT Part No. B2G32UYNB20C000213U1930			
Tentative Product	*****	*****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	03/11/2021	Version 1.0	Page 8/15

#### Precaution for Use

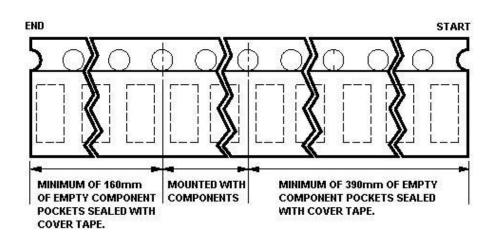
- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs.If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs.Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

7				
Official Product	HT Part No. B2G32UYNB20C000213U1930			
Tentative Product	******	*****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	03/11/2021	Version 1.0	Page 9/15

### Packaging Tape Dimension

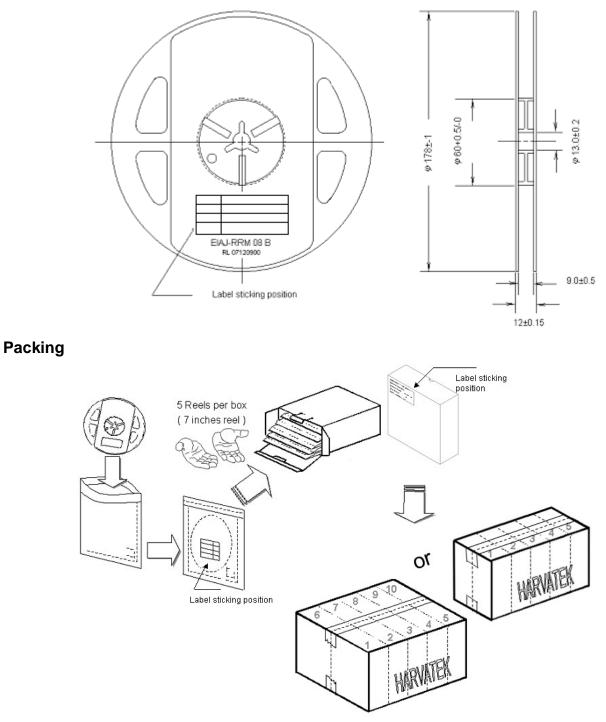


Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.75±0.05	1.37±0.05	0.5±0.05	ЗK



Official Product	HT Part No. B2G32UYNB20C000213U1930			
Tentative Product	*****	*****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	03/11/2021	Version 1.0	Page 10/15

### **Reel Dimension**



5 or 10 boxes per carton is available depending on shipment quantity.

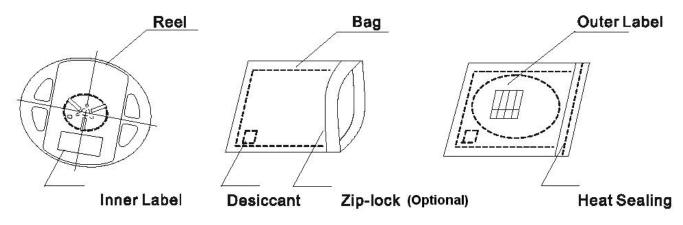
7				
Official Product	HT Part No. B2G32UYNB20C000213U1930			
Tentative Product	*****	****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	03/11/2021	Version 1.0	Page 11/15

### **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



### Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks. The conditions are as followings:

- 1.  $60\pm3^{\circ}C\times(12\sim24hrs)$  and <5% RH, taped reel type.
- 2. 100±3°C ×(45min~1hr), bulk type.
- 3. 130±3°C ×(15min~30min), bulk type.

### Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlGaInP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

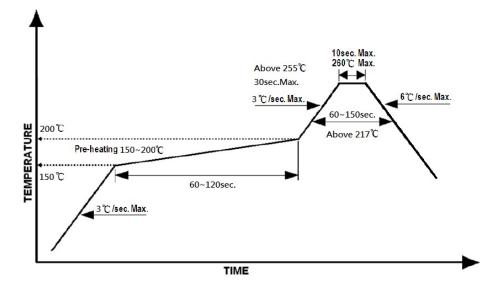
Official Product	HT Part No. B2G32UYNB20C000213U1930			
Tentative Product	*****	****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	03/11/2021	Version 1.0	Page 12/15

### **Reflow Soldering**

Recommend soldering paste specifications:

- 1. Operating temp.: Above  $217^{\circ}$ C ,60~150 sec.
- 2. Peak temp.:260 <sup>O</sup>CMax.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 <sup>O</sup>C max, <3min

7				
Official Product	HT Part No. B2G32UYNB20C000213U1930			
Tentative Product	*****	****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	03/11/2021	Version 1.0	Page 13/15

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

### **Revise History**

Rev.	Descriptions	Date	Page
-	-	08/28/2017	-
1.0	Update to official version & Add Customer Product Code	03/11/2021	P5

Official Product	HT Part No. B2G32UYNB20C000213U1930			
Tentative Product	*****	****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	03/11/2021	Version 1.0	Page 14/15